

# HD74LS241

Octal Buffers / Line Drivers / Line Receivers  
(non inverted three-state outputs)

REJ03D0460-0200

Rev.2.00

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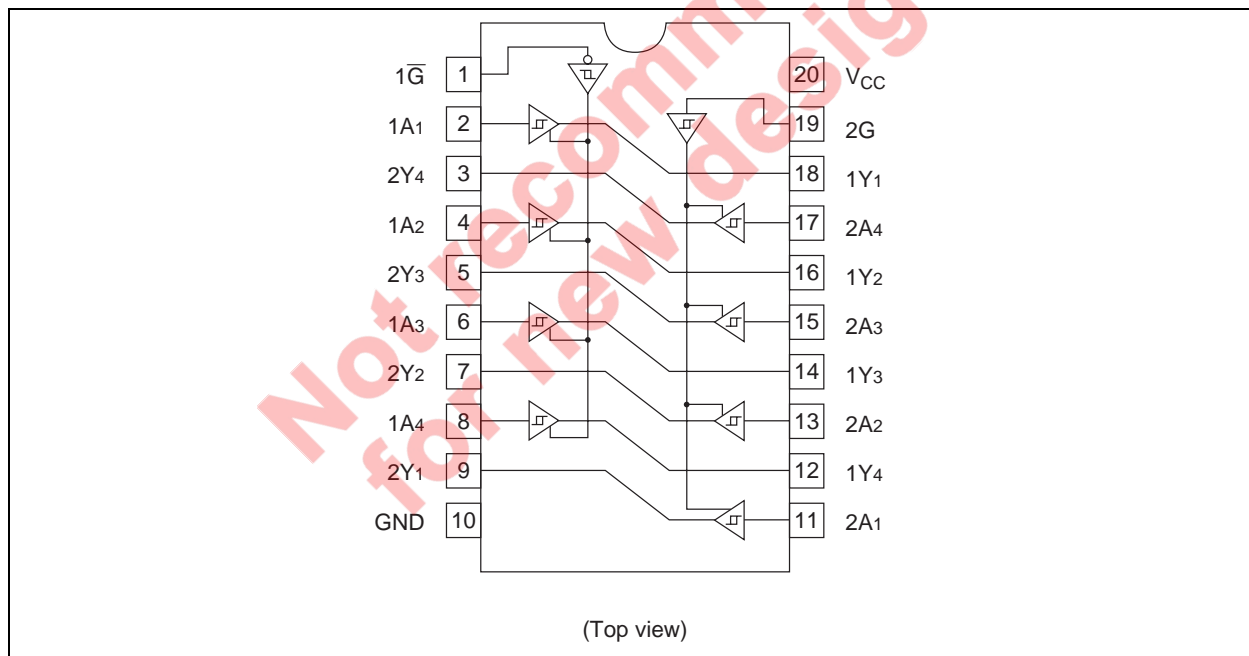
## Features

- Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LS241P	DILP-20 pin	PRDP0020AC-B (DP-20NEV)	P	—
HD74LS241FPEL	SOP-20 pin (JEITA)	PRSP0020DD-B (FP-20DAV)	FP	EL (2,000 pcs/reel)

Note: Please consult the sales office for the above package availability.

## Pin Arrangement

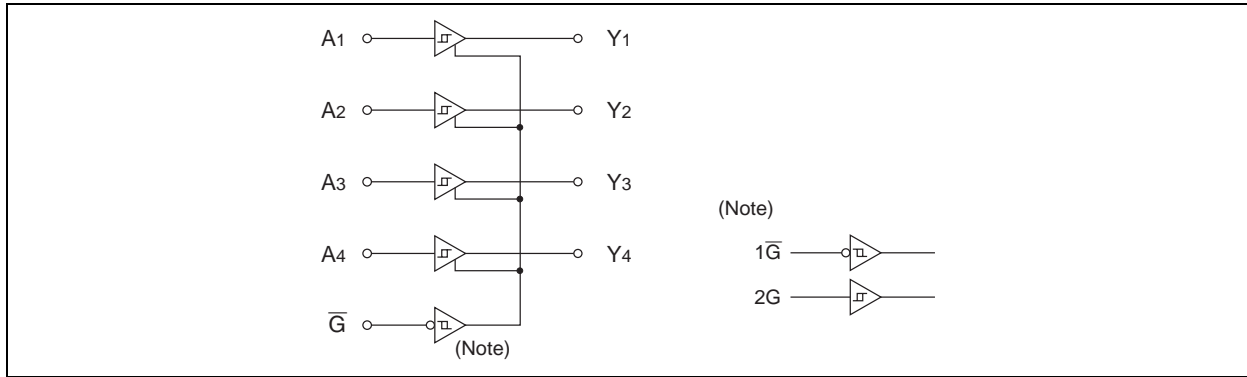


## Function Table

Inputs		Output	
$1\bar{G}$	2G	A	Y
H	L	X	Z
L	H	H	H
L	H	L	L

Note: H; high level, L; low level, X; irrelevant, Z; off (high-impedance) state of a 3-state output

**Block Diagram (1/2)**



**Absolute Maximum Ratings**

Item	Symbol	Ratings	Unit
Supply voltage	$V_{CC}$	7	V
Input voltage	$V_{IN}$	7	V
Power dissipation	$P_T$	400	mW
Storage temperature	$T_{stg}$	-65 to +150	°C

Note: Voltage value, unless otherwise noted, are with respect to network ground terminal.

**Recommended Operating Conditions**

Item	Symbol	Min	Typ	Max	Unit
Supply voltage	$V_{CC}$	4.75	5.00	5.25	V
Output current	$I_{OH}$	—	—	-15	mA
	$I_{OL}$	—	—	24	mA
Operating temperature	$T_{opr}$	-20	25	75	°C

Not recommended for new design

## Electrical Characteristics

(Ta = -20 to +75 °C)

Item	Symbol	min.	typ.*	max.	Unit	Condition
Input voltage	V <sub>IH</sub>	2.0	—	—	V	
	V <sub>IL</sub>	—	—	0.8	V	
Hysteresis	V <sub>T+</sub> - V <sub>T-</sub>	0.2	0.4	—	V	V <sub>CC</sub> = 4.75 V
Output voltage	V <sub>OH</sub>	2.4	—	—	V	V <sub>CC</sub> = 4.75 V, V <sub>IH</sub> = 2 V
		2.0	—	—		
	V <sub>OL</sub>	—	—	0.4	V	V <sub>CC</sub> = 4.75 V, V <sub>IH</sub> = 2 V, V <sub>IL</sub> = 0.8 V
		—	—	0.5		
Off-state output current	I <sub>OZH</sub>	—	—	20	μA	V <sub>O</sub> = 2.7 V
	I <sub>OZL</sub>	—	—	-20	μA	V <sub>O</sub> = 0.4 V
Input current	I <sub>IH</sub>	—	—	20	μA	V <sub>CC</sub> = 5.25 V, V <sub>I</sub> = 2.7 V
	I <sub>IL</sub>	—	—	-0.2	mA	V <sub>CC</sub> = 5.25 V, V <sub>I</sub> = 0.4 V
	I <sub>I</sub>	—	—	0.1	mA	V <sub>CC</sub> = 5.25 V, V <sub>I</sub> = 7 V
Short-circuit output current	I <sub>OS</sub>	-40	—	-225	mA	V <sub>CC</sub> = 5.25 V
Supply current**	Outputs high	—	13	23	mA	V <sub>CC</sub> = 5.25 V
	Outputs low	—	27	46		
	All outputs disabled	—	32	54		
Input clamp voltage	V <sub>IK</sub>	—	—	-1.5	V	V <sub>CC</sub> = 4.75 V, I <sub>IN</sub> = -18 mA

Notes: \* V<sub>CC</sub> = 5 V, Ta = 25°C\*\* I<sub>CC</sub> is measured with all outputs open.

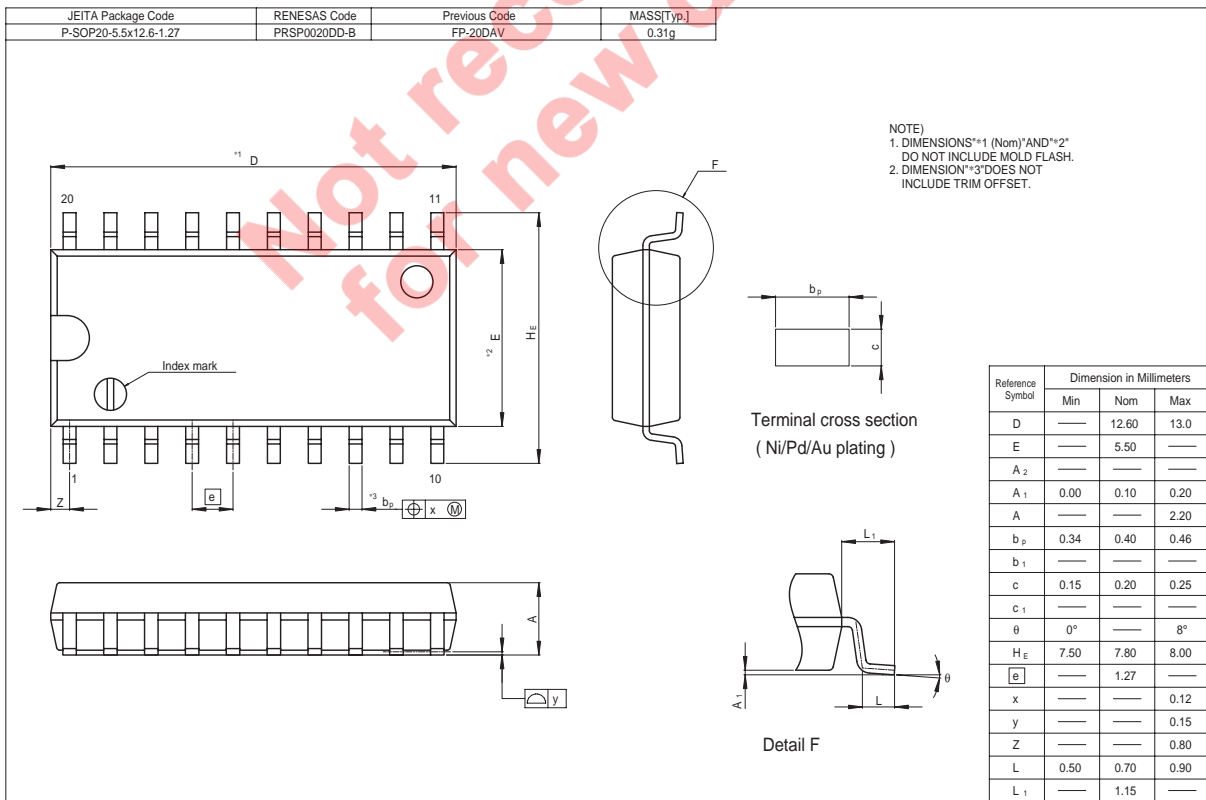
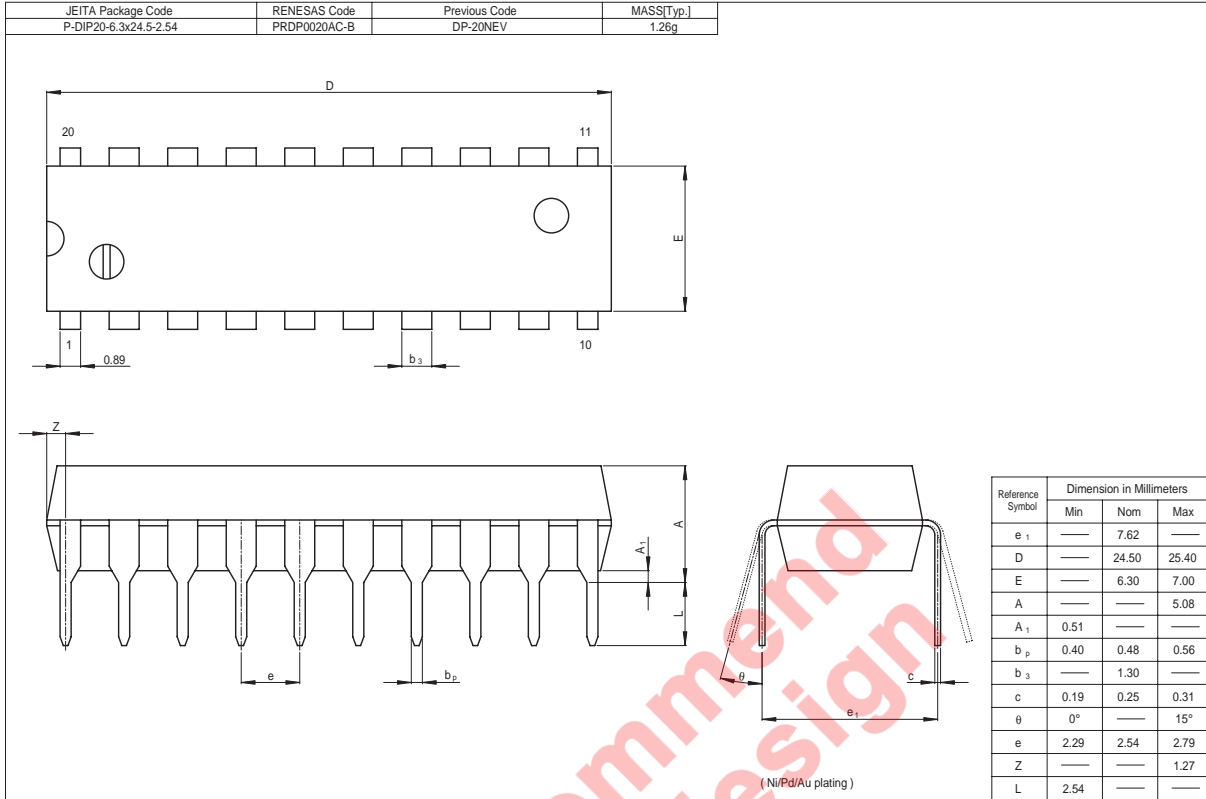
## Switching Characteristics

(V<sub>CC</sub> = 5 V, Ta = 25°C)

Item	Symbol	min.	typ.	max.	Unit	Condition
Propagation delay time	t <sub>PLH</sub>	—	12	18	ns	C <sub>L</sub> = 45 pF, R <sub>L</sub> = 667 Ω
	t <sub>PHL</sub>	—	12	18		
Output enable time	t <sub>ZL</sub>	—	20	30	ns	
	t <sub>ZH</sub>	—	15	23		
Output disable time	t <sub>LZ</sub>	—	15	25	ns	C <sub>L</sub> = 5 pF, R <sub>L</sub> = 667 Ω
	t <sub>HZ</sub>	—	10	18		

Note: Refer to Test Circuit and Waveform of the Common Item "TTL Common Matter (Document No.: REJ27D0005-0100)".

Package Dimensions



**Renesas Technology Corp.** Sales Strategic Planning Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan

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**Renesas Technology America, Inc.**

450 Holger Way, San Jose, CA 95134-1368, U.S.A  
Tel: <1> (408) 382-7500, Fax: <1> (408) 382-7501

**Renesas Technology Europe Limited**

Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K.  
Tel: <44> (1628) 585-100, Fax: <44> (1628) 585-900

**Renesas Technology Hong Kong Ltd.**

7th Floor, North Tower, World Finance Centre, Harbour City, 1 Canton Road, Tsimshatsui, Kowloon, Hong Kong  
Tel: <852> 2265-6688, Fax: <852> 2730-6071

**Renesas Technology Taiwan Co., Ltd.**

10th Floor, No.99, Fushing North Road, Taipei, Taiwan  
Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

**Renesas Technology (Shanghai) Co., Ltd.**

Unit2607 Ruijing Building, No.205 Maoming Road (S), Shanghai 200020, China  
Tel: <86> (21) 6472-1001, Fax: <86> (21) 6415-2952

**Renesas Technology Singapore Pte. Ltd.**

1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632  
Tel: <65> 6213-0200, Fax: <65> 6278-8001